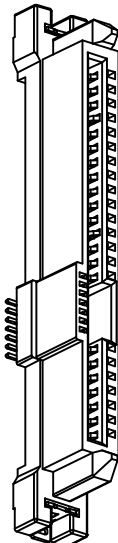


客户图



SPECIFICATIONS:

Contact current Rating:

1.5 Amperes

Dielectric Withstanding Voltage:AC 150V(RMS)
Insulation resistance:1000Megohms Minimum.

Contact Resistance:

30mΩ Max

50mΩMax for other contacts

Mechanical Characteristics:

Mating Force:45 Newtons.Maximum

Unmating Force:10 Newtons.Minimum.

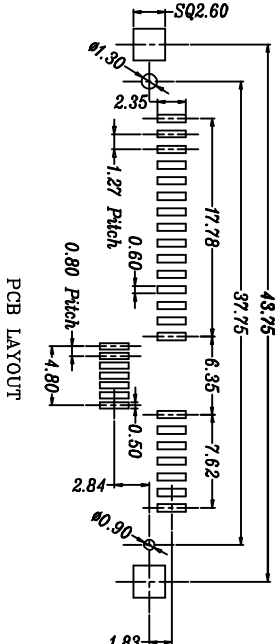
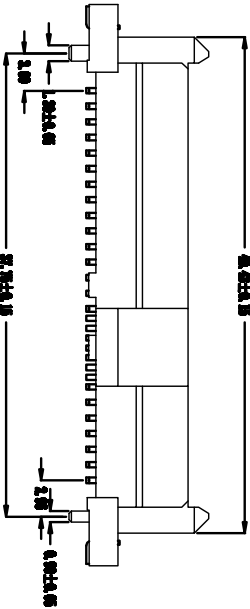
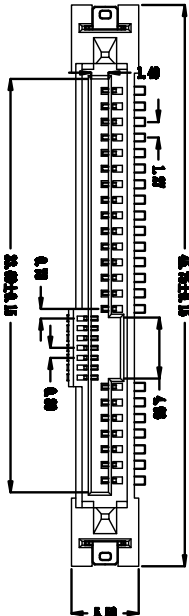
FINISH:

CONTACT:1u" 5u" 15u" GOLD/TIN PLATING ON CONTACT AREA

100u" MIN. TIN PLATING ON SOLDERTAILS

50u" MIN.NICKEL UNDERPLATING OVER ALL PAD:100u" MIN. TIN PLATING ON SOLDERTAILS

50u" MIN.NICKEL UNDERPLATING OVER ALL



PCB LAYOUT



ITEM	DIM	A
1	2.43	

ITEM	NAME	Q'TY	MATERIAL / PLATING
D	PAD	2	C2680R-H T=0.30 Contact Plating Au,Solder Area Bright Sn
C	CONTACT	7	C2680R-H T=0.25 Contact Plating Au,Solder Area Bright Sn
B	CONTACT	15	C2680R-H T=0.25 Contact Plating Au,Solder Area Bright Sn
A	HOUSING	1	LCP +30%G.F. BLACK UL94V-0

QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DRAFT WHERE APP	THIRD ANGLE PROJECTION	TITLE:
▽ ₀	MM X ±0.35 XX ±0.25 XXX ±0.15	LICABLE MUST REMAIN WITHIN DIMENSIONS	DRAWN BY DATE Dean Oct.20.2014	SAS 29P #1180#SMT
▽ ₀	INCH X ± XX ± XXX ±		APPROVED BY DATE	PART NO. XDSA-1810-2901
	ANGULAR ±1°		CHECKED BY DATE	DWG NO.
				SHEET NO. 1/1

深圳市连欣科技有限公司